S1 Global Status

Jim Kerby 12 July 2010

S1-Global

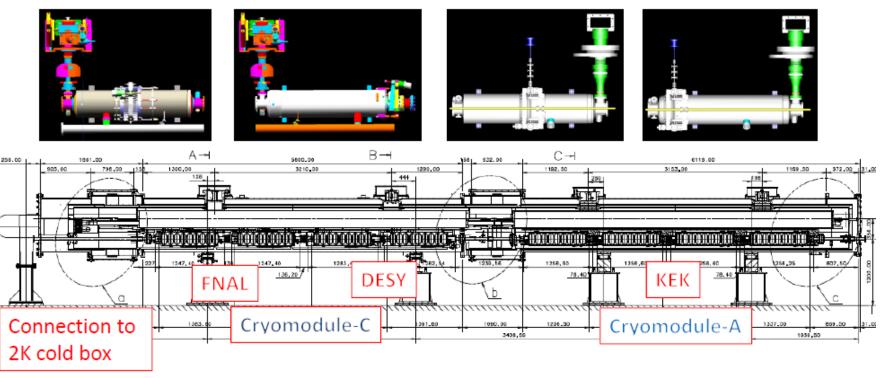
The main target of the S1-Global:

Operating a cryomodule with an average accelerating gradient of 31.5 MV/m with 8 cavities under the international research collaboration.

Included research subjects:

- 1. Experience the design, assembly and the alignment procedures for cavity packages from participating parties.
- 2. Measure the heat loads for the cavity packages and the cryomodule for the static and the 31.5 MV/m dynamic conditions.
- 3. Conduct the comparative studies of performance of cavities from the participating institutes.
- 4. Attempt to attain an average accelerating gradient of 31.5 MV/m in a pulsed RF operation at 5Hz with 1ms flat-top length, 0.07% rms amplitude variation and 0.35 degree rms phase variation.
- 5. Advance implementation of the 'plug-compatibility concept'

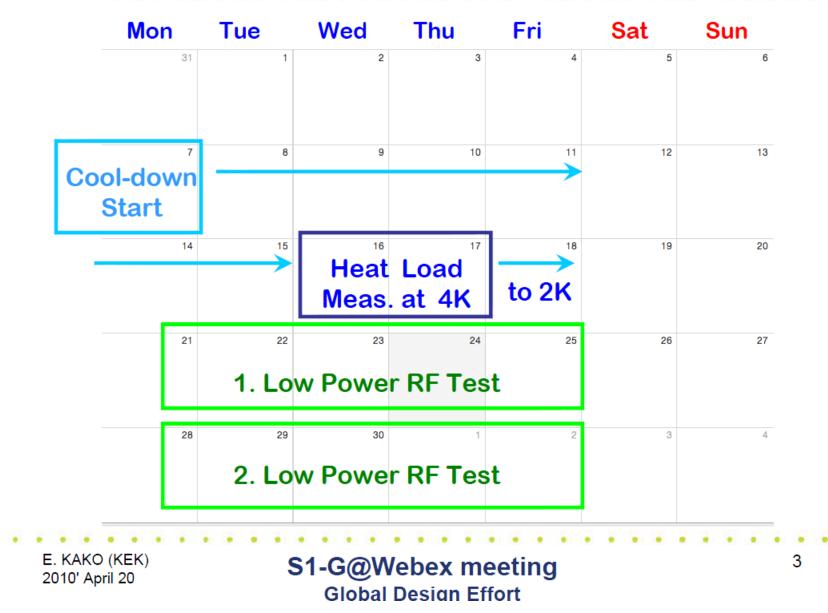
S1-Global cryomodule overview



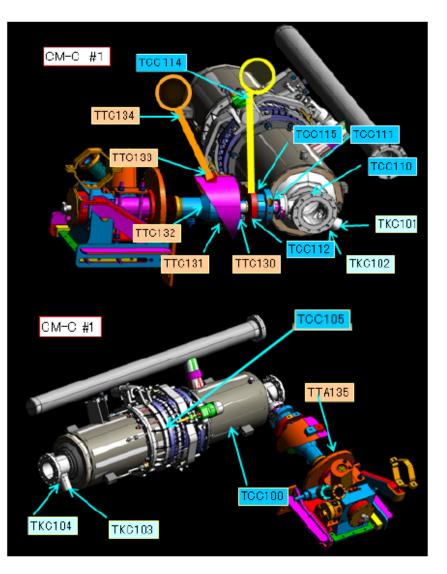
- S1-Global collaborative profile
 - INFN: Design and construction of the 6m Module-C for DESY and FNAL cavities
 - DESY: Two TESLA type cavities with Saclay tuner
 - FNAL: Two TESLA type cavities with blade tuner
 - SLAC: Power distribution system for Module-C and input coupler conditioning
 - KEK: 6m Module-A for KEK cavities, four TESLA-like cavities and infrastructure for completing the module tests



June, 2010



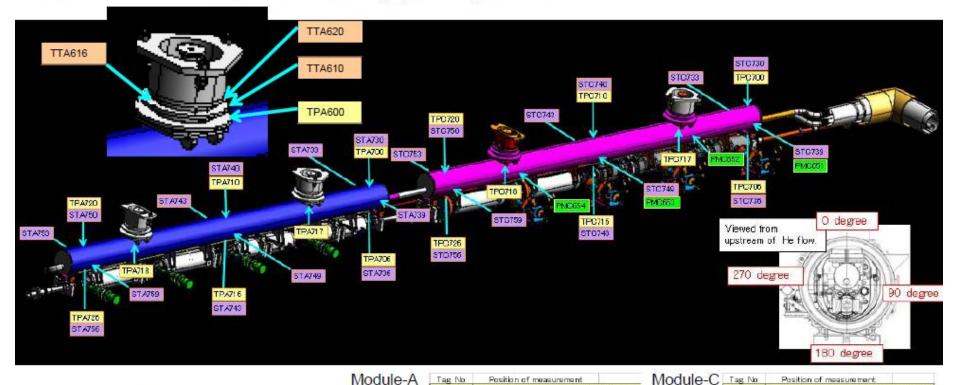
Temperature sensors on cavity jacket and input coupler



Tag No	Position of measurement					
TCC1D0	Helium Vessel					
TKC101	HOM coupler in the input coupler side-top					
TKG102	HOM coupler in the input coupler side-bottom					
T KC1 D3	HOM coupler in the non-input coupler side-top					
TKC104	HOM coupler in the nor-input coupler side-bottom					
TCC105	Piezo					
TCC110	Connection area of input coupler with beam pipe					
TCC111	5K thermal intercept of input coupler (beam pipe side)					
TCC112	5K thermal intercept of input coupler (body)					
TCC114	5K thermal intercept of input coupler (cooling pipe side)					
TTC115	5K thermal intercept of input coupler (intercept side)					
TTC130	80K thermal intercept of input coupler (beam pipe side)					
TTC131	80K thermal intercept of input coupler (body)					
TTC132	80K thermal intercept of input coupler (vacuum vessel side)					
TTC133	80K thermal intercept brade of input coupler (coupler side)					
TTC134	80K thermal intercept brade of input coupler (cooling pipe side)					
TTC135	Input coupler (room temperature and in the vacuum vessel)					

Cernox:7, Carbon resistor:4, CC: 6 Cavity vessel= 1 Input coupler= 11 (including thermal intercepts) HOM coupler= 4 Piezo= 1

Sensors on GRP and support posts



GRP

PtCo : 20, CC thermocouples : 12 GRP= 16 Support Post= 20

For measuring the GRP deformation Strain gauge: 24 positions (3 positions along the GRP axis, and 4 azimuthal positions for one GRP)

GRP TPA708 Upstream-bottom TPC708 Upstream-bottom TPA710 Center-top TPC710 Center-top TPA716 Center-bottom TPC716 Center-kattam TPA717 Connection area between S.P and GRP(F) TPO717 Donnection area between S.P and GRP(F) TPA718 Connection area between S.P and GRP(M) TPC718 Connection area between S.P and GRP(F) TPA720 Downstream-top (end flange side) TPC720 Downstreamintop (and flange side) TPA726 Downstream-bottom TPC726 Downstream-bottom STA730 IO degree in the side of Upstream STC730 |0 device in the side of Upstream STA733 90 degree in the side of Upstream ST0793 90 degree in the side of Upstream STA736 180 degree in the side of Upstream STC736 180 degree in the side of Upstream STA739 270 degree in the side of Upstream ST0739 270 degree in the side of Upstream STC740 0 degree in the center STA740 O degree in the center STA743 30 degree in the center STC743 90 degree in the center STA746 180 degree in the center STC746 180 degree in the center STA749 270 degree in the center STC749 270 degree in the center STA750 O degree in the side of end flange STC750 0 degree in the side of end flange STA753 90 degree in the side of end flange. STO753 80 degree in the side of end flange STA756 180 degree in the side of end flange STC756 180 degree in the side of end flange STA759 270 degree in the side of end flange STC759 270 degree in the side of end flange

TPC700

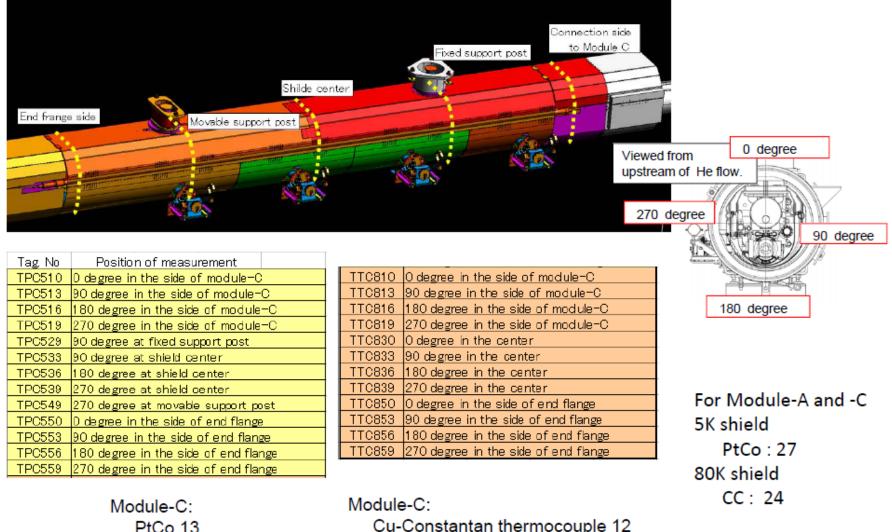
2010/03/29

ILC10-GDE @Beijing

TPA700 Upstream-top (Module-A connection side)

Upstream-top (Module=C connection side)

Temperature sensors on thermal shields

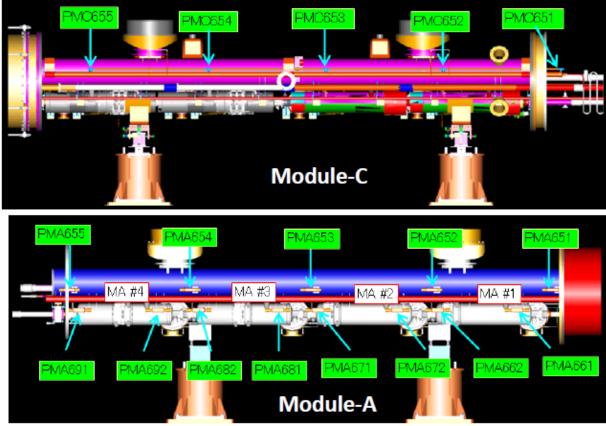


Cu-Constantan thermocouple 12

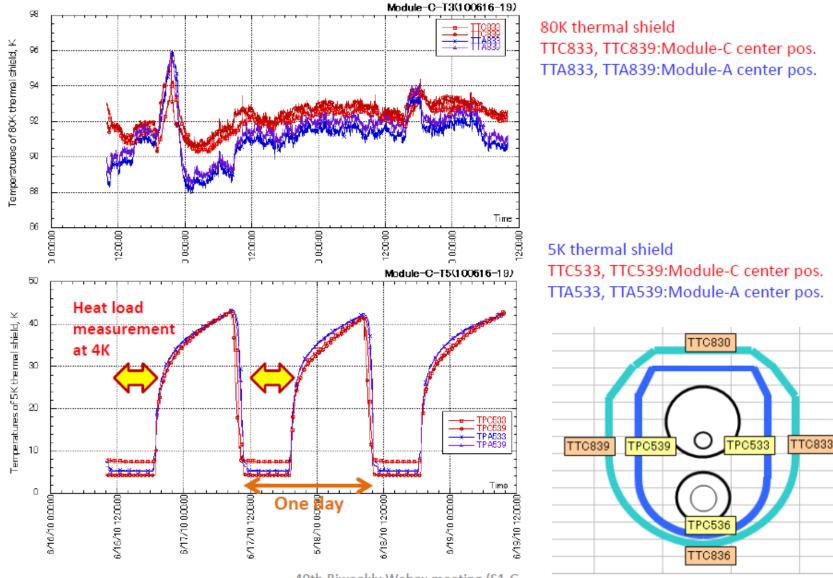
Position measurement of cavities and GRP

Measurement of position of cavities and GRP by WPM

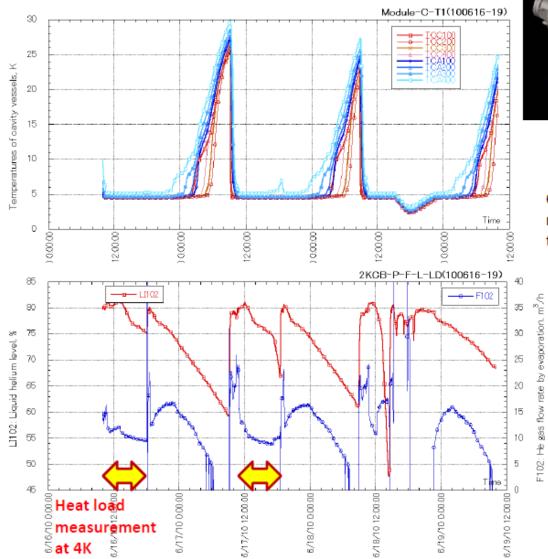
- Module-C
 - 5 WPMs are assembled on the GRP.
- Module-A
 - 5 WPMs on the GRP and 2 WPMs for each cavity are assembled. In total, 13 WPMs.

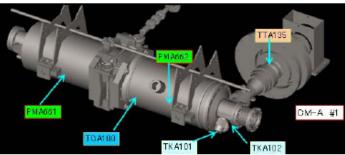


Thermal conditions at heat load measurement at 4K (June 16 - 17)



40th Biweekly Webex meeting (S1-G, Cryomodule, Cryogenics)





TCC100, 200, 300, 400:Module-C vessels TCA100, 200, 300, 400:Module-A vessels

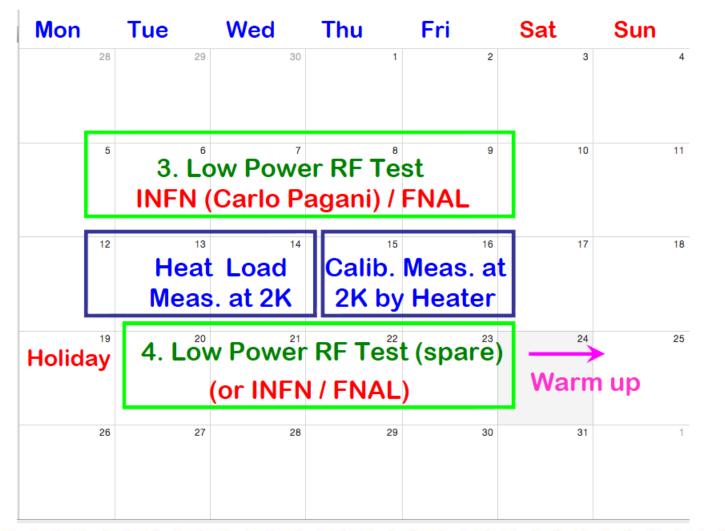
Clearly, the starting time of temperature rises of Module-A cavity vessels are earlier than the time for Module-C cavity vessels.



40th Biweekly Webex meeting (S1-G, Cryomodule, Cryogenics)



July, 2010



E. KAKO (KEK) 2010' April 20 S1-G@Webex meeting Global Design Effort



Frequency change during cool-down

[MHz]

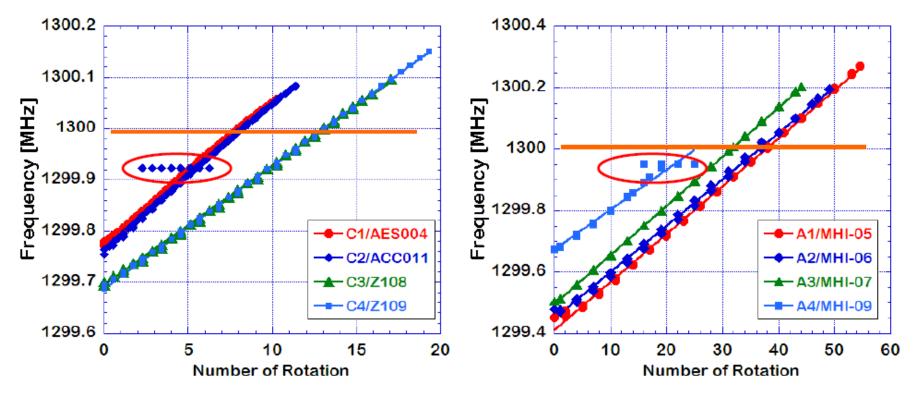
	Cavity	room temp.	∆ fo	4.2 K	⊿ fo	2.0 K
1.	C1/AES-004	1297.989	1.959	1299.948	0.168	1299.780
2.	C2/ACC-011	1297.974	1.949	1299.922	0.157	1299.766
3.	C3/Z-108	1297.768	1.977	1299.745	0.044	1299.701
4.	C4/Z-109	1297.755	1.986	1299.741	0.045	1299.697
5.	A1/MHI-05	1297.793	1.990	1299.784	0.310	1299.473
6.	A2/MHI-06	1297.806	1.978	1299.784	0.300	1299.483
7.	A3/MHI-07	1297.664	1.977	1299.641	0.127	1299.514
8.	A4/MHI-09	1297.885	1.984	1299.869	0.184	1299.684

△ fo (300K - 4.2K) = 1.95 ~ 1.99 MHz

Δfo (4.2K – 2.0K) = -160 kHz (blade), -45 kHz (Saclay) -305 kHz (Slide-jack/center), -155 kHz (Slide-jack/end) E. KAKO (KEK) 2010' June 29 Slobal Design Effort **Stroke of Motor Tuner**

Cryomodule - C

Cryomodule - A



Trouble of two motor tuners occurred in C2/ACC011 (Blade) and A4/MHI-09 (Slide-Jack/end) !!

E. KAKO (KEK) 2010' June 29

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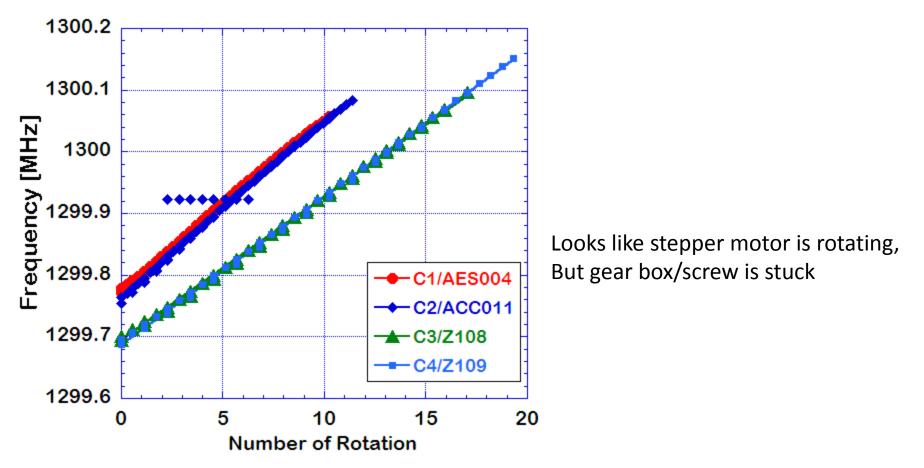
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Summary (from Y. Pischalnikov)

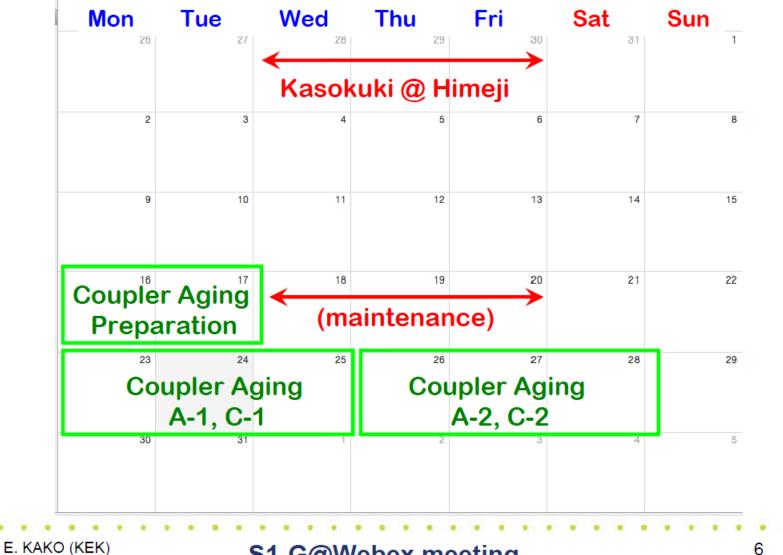
FNAL Cavities (AES04 &ACC11) C1/AES04 -OK C2/ACC11:

Slow Tuner after several cycles stuck at Frequency 1299.92MHz One piezo -limit NV=100V →

DF=530Hz (this maybe not enough for Eacc~30MV/m)



August, 2010

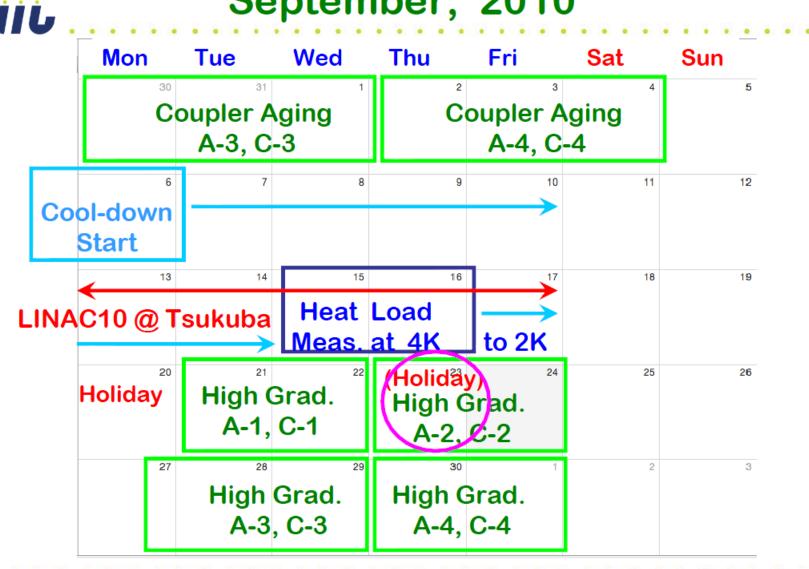


2010' April 20

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September, 2010

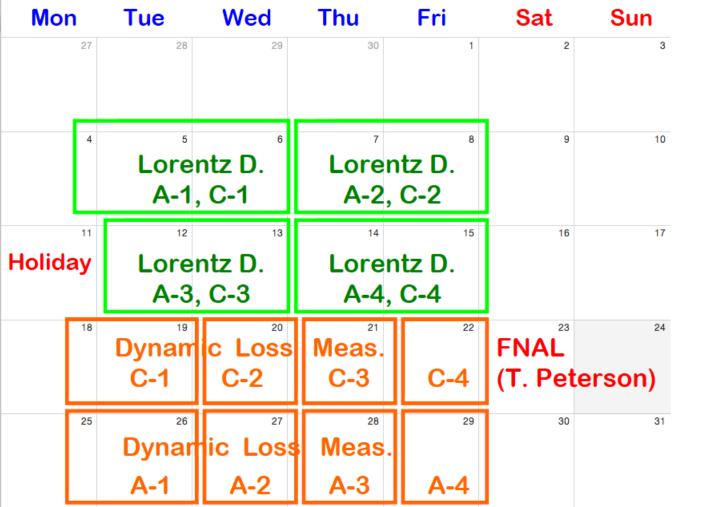


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October, 2010

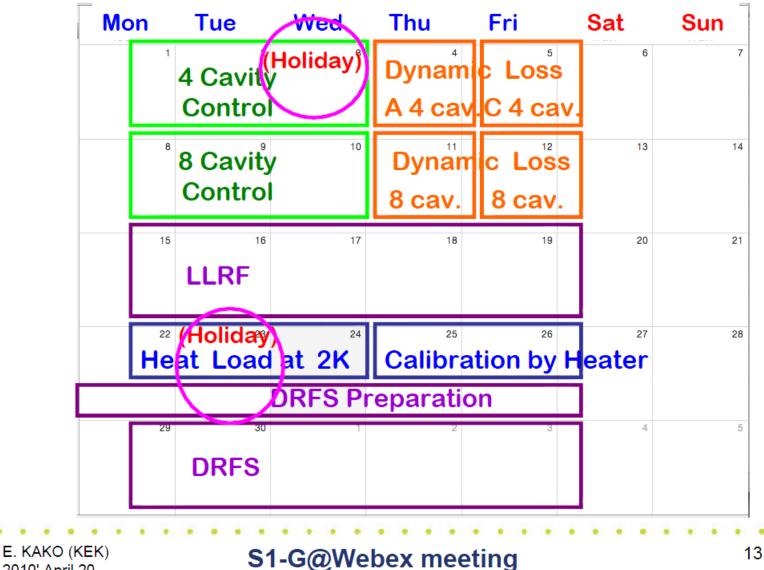


E. KAKO (KEK) 2010' April 20 S1-G@Webex meeting Global Design Effort



2010' April 20

November, 2010



Global Design Effort

Summary

- S1 Global assembly and initial cooldown and tests proceeding well and according to schedule set ~7 months ago
- Though gradient goal will more than likely not be reached, components and instrumentation provide opportunities for comparisons and measurements not available on the same timescale as other tests
- ILC is supporting visits (check w/ Dept Head for conflicts, priorities, etc!)